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# United States Patent [19]

Harada et al.

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[54] **MODULE FOR RECEIVING INFRA-RED SIGNAL OF REMOTE CONTROLLER**

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[73] Assignee: **Sony Corporation**, Tokyo, Japan

[\*\*] Term: **14 Years**

[21] Appl. No.: **34,927**

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[30] **Foreign Application Priority Data**

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Jun. 30, 1994 [JP] Japan ..... 6-19421

[52] **U.S. Cl.** ..... **D13/165**

[58] **Field of Search** ..... D13/165, 182;  
174/52.4; 361/730, 752; 250/239; 257/432

[56] **References Cited**

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LED circuit board indicators on p. 155 of *Arrow Electronics* catalog ©1988.

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*Primary Examiner*—Joel Sincavage  
*Attorney, Agent, or Firm*—Beveridge, DeGrandi, Weilacher & Young

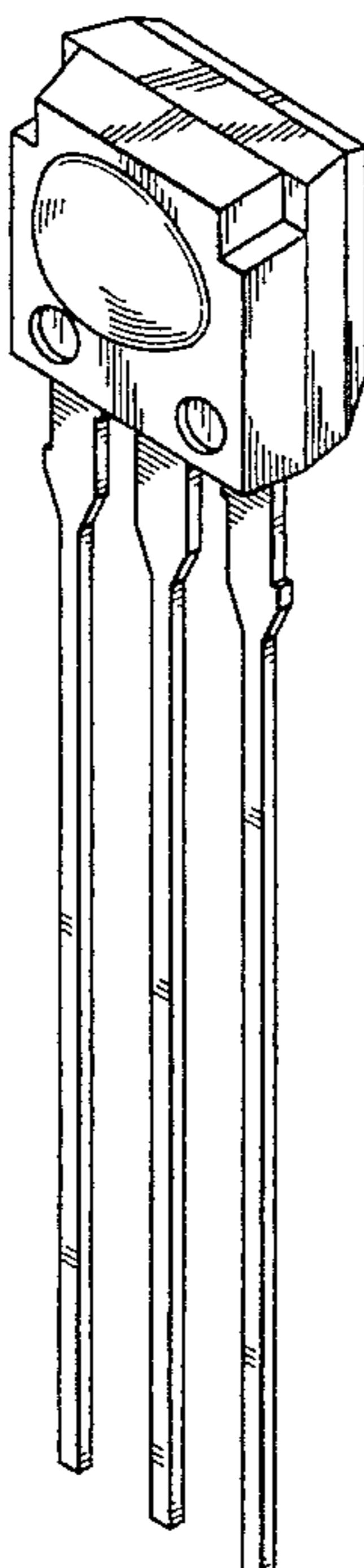
[57] **CLAIM**

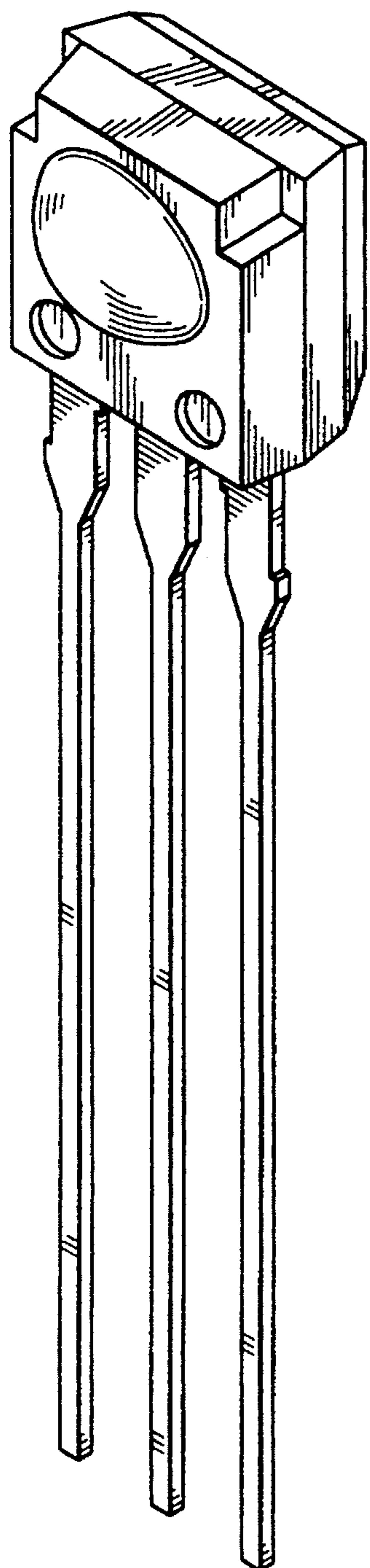
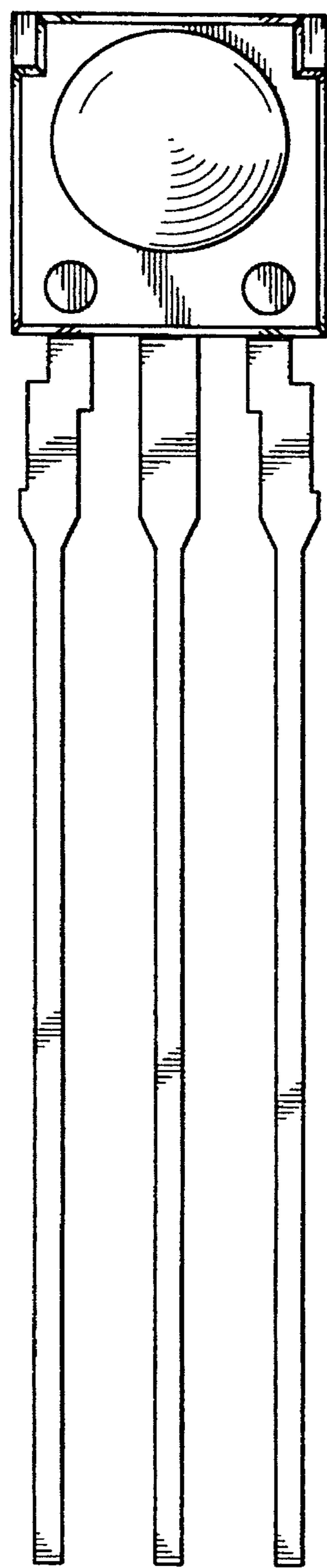
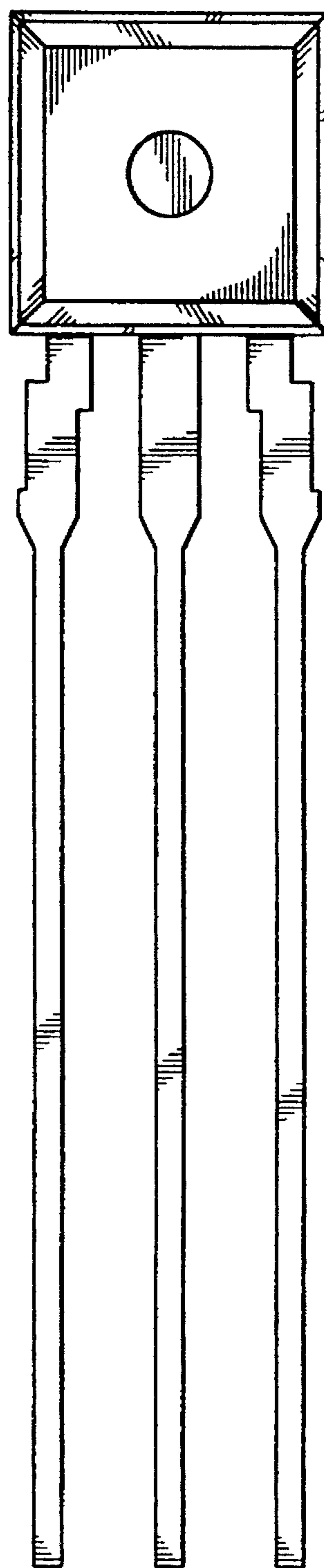
The ornamental design for a module for receiving an infra-red signal of a remote controller, as shown and described.

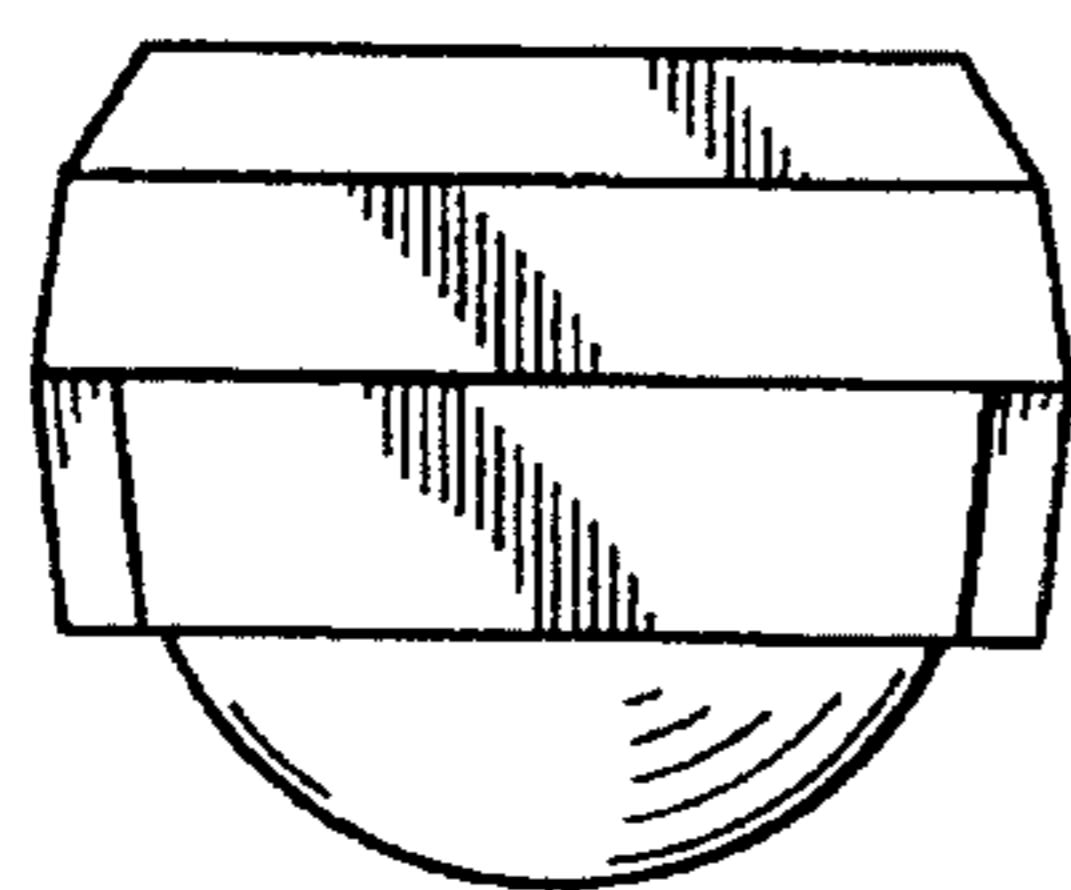
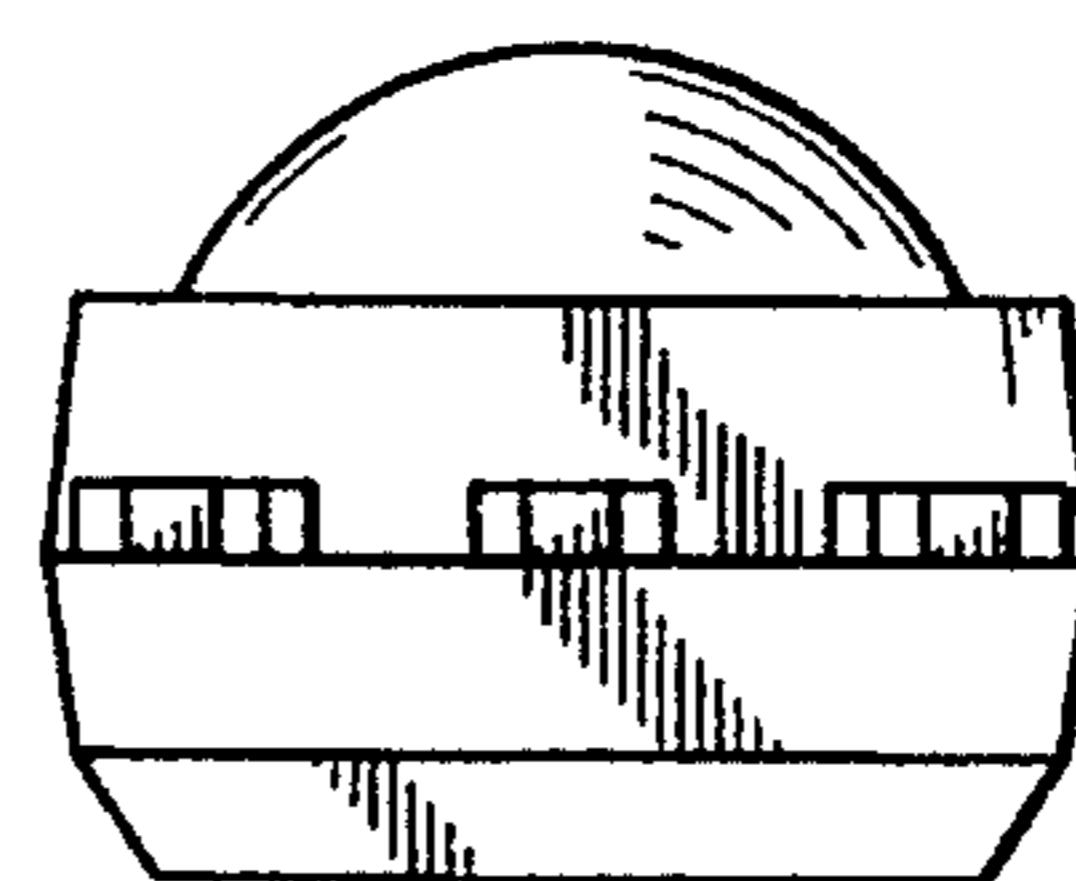
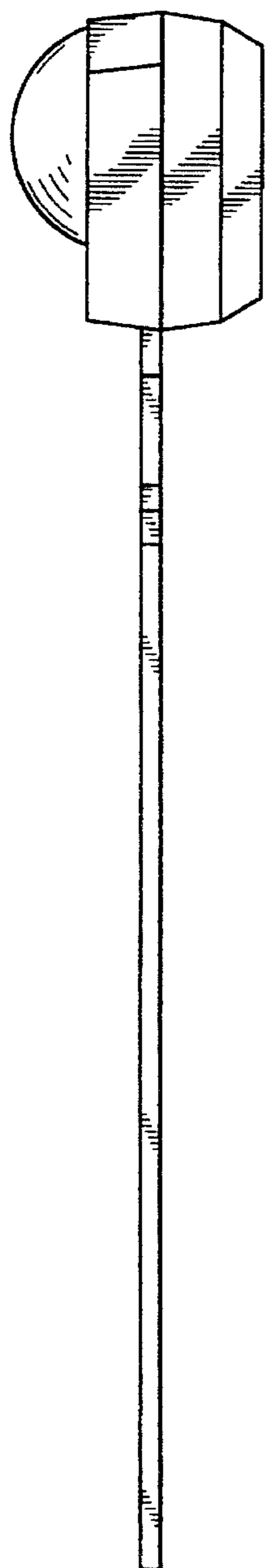
**DESCRIPTION**

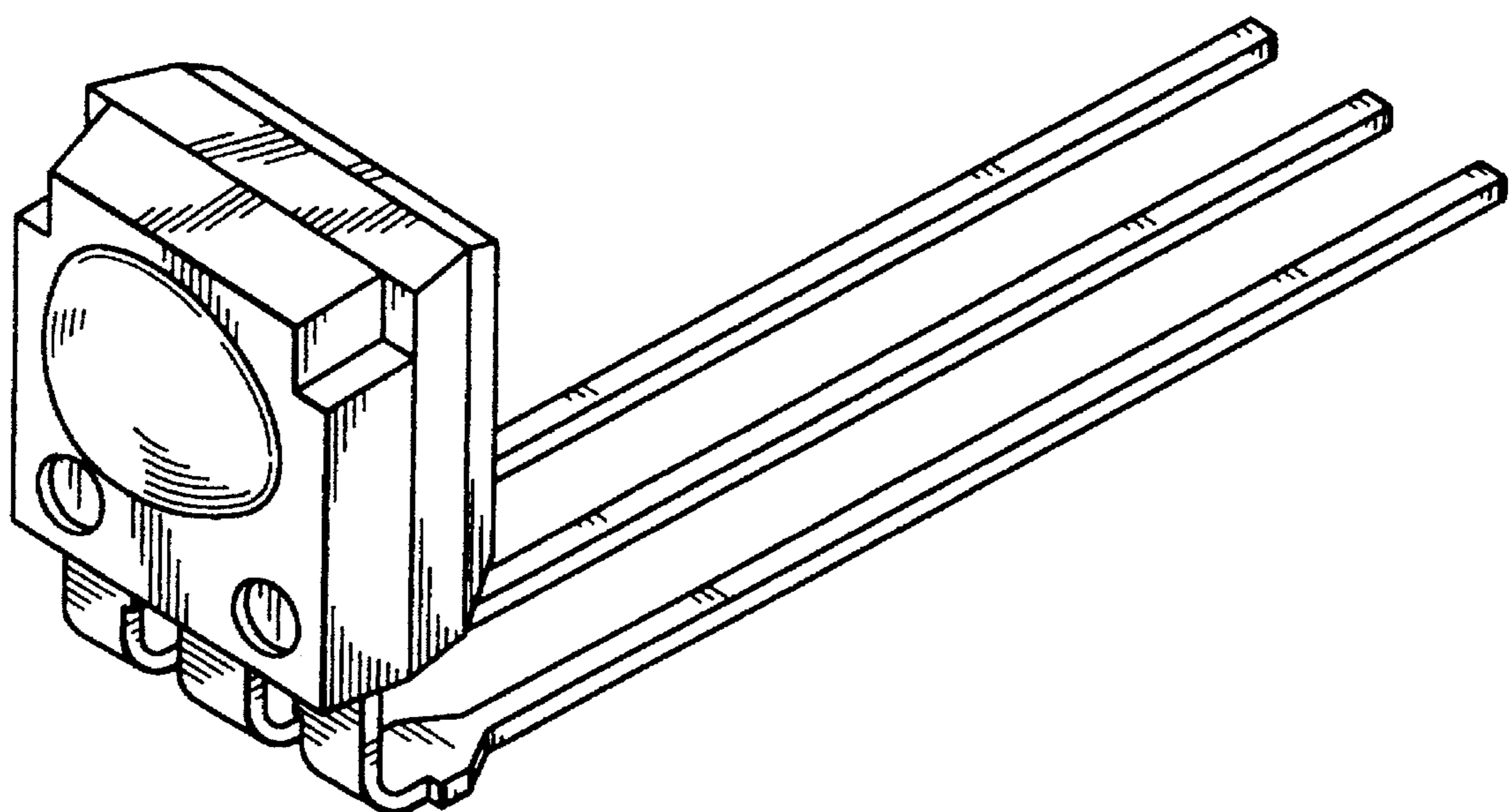
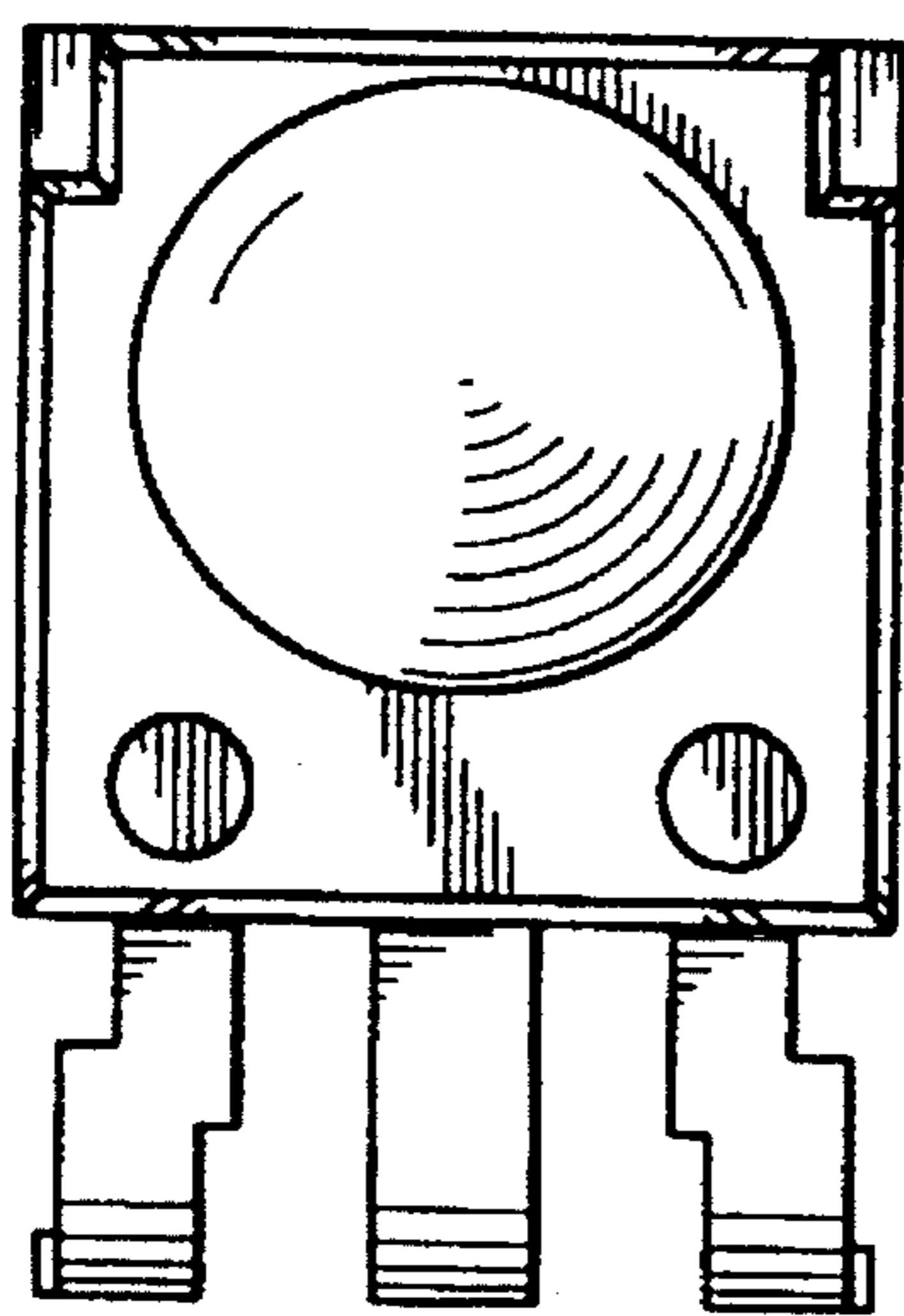
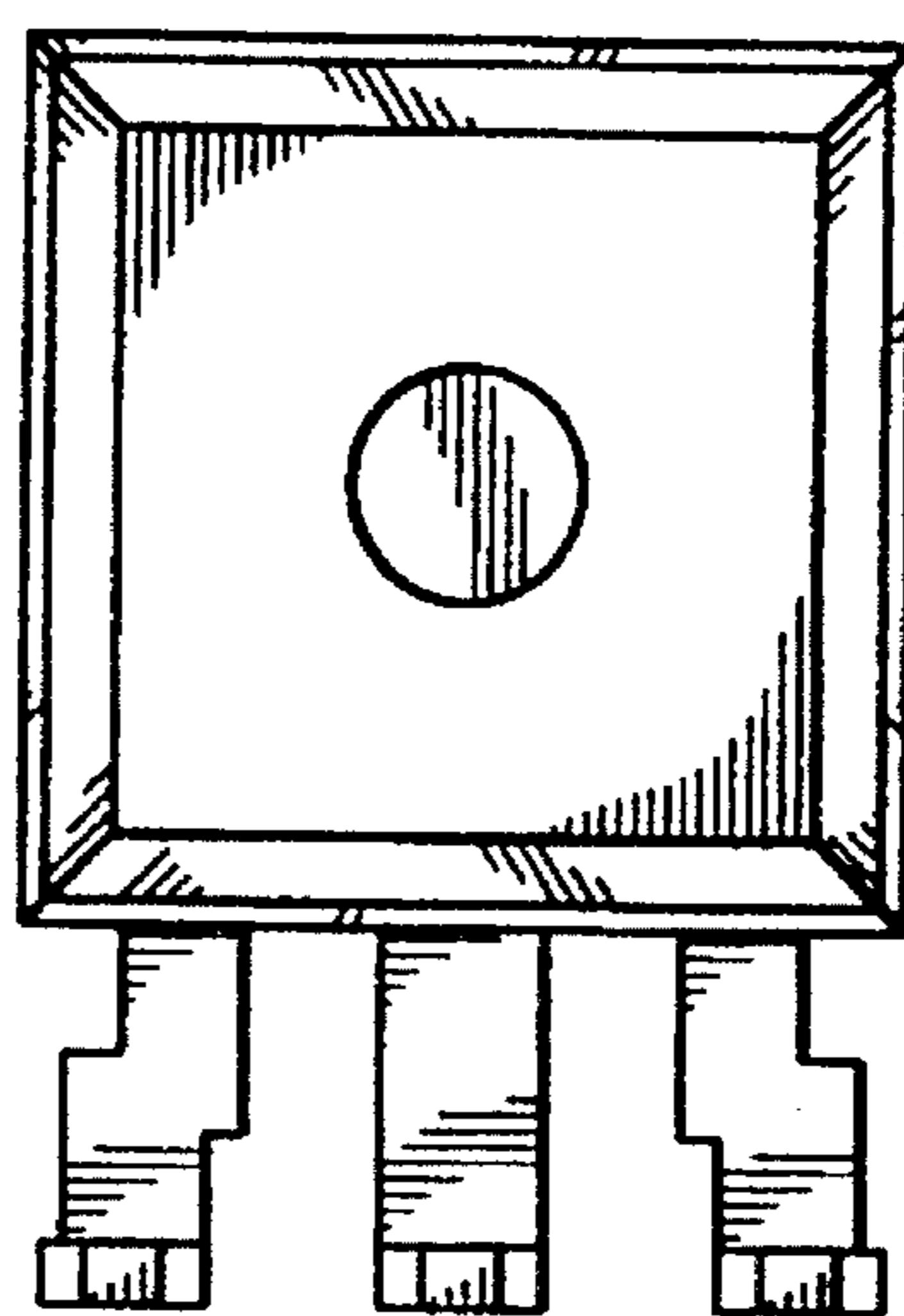
FIG. 1 is a perspective view of a first embodiment of the module for receiving an infra-red signal of a remote controller of the present invention showing our new design; FIG. 2 is a front plan view of the first embodiment of FIG. 1; FIG. 3 is a rear plan view of the first embodiment of FIG. 1; FIG. 4 is a top plan view of the first embodiment of FIG. 1; FIG. 5 is a bottom plan view of the first embodiment of FIG. 1; FIG. 6 is a right side plan view of the first embodiment of FIG. 1; the left side plan view is symmetrically identical to FIG. 6 and is therefore not shown; FIG. 7 is a perspective view of the second embodiment of the module for receiving infra-red signal of a remote controller of the present invention showing our new design; FIG. 8 is a front plan view of the second embodiment of FIG. 7; FIG. 9 is a rear plan view of the second embodiment of FIG. 7; FIG. 10 is a top plan view of the second embodiment of FIG. 7; FIG. 11 is a bottom plan view of the second embodiment of FIG. 7; and, FIG. 12 is a right plan view of the second embodiment of FIG. 7; the left plan view is symmetrically identical to FIG. 12 and is therefore not shown.

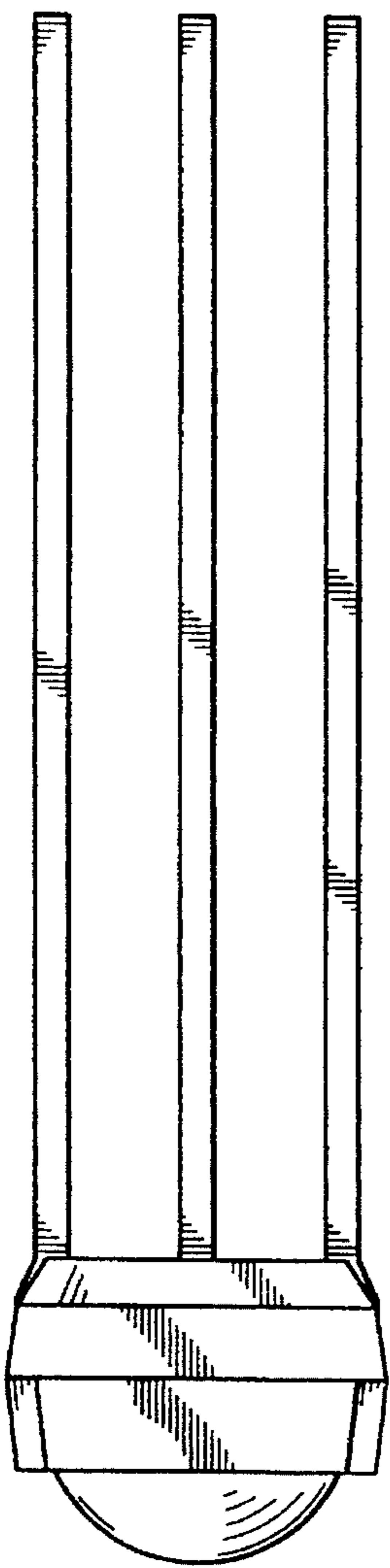
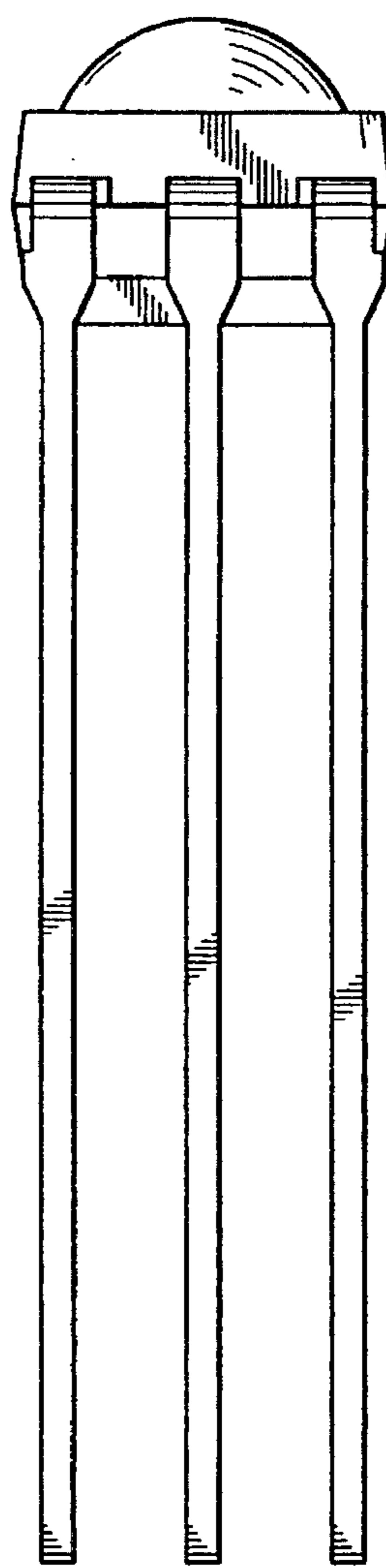
**1 Claim, 4 Drawing Sheets**



**FIG. 1****FIG. 2****FIG. 3**

**FIG. 4****FIG. 5****FIG. 6**

**FIG. 7****FIG. 8****FIG. 9**

**FIG. 10****FIG. 11****FIG. 12**